

MN101C49G , MN101C49H , MN101C49K

Type	MN101C49G	MN101C49H	MN101C49K
ROM (×8-bit) External memory can be expanded	128 K	160 K	224 K
RAM (×8-bit) External memory can be expanded	4 K	6 K	10 K
Package	QFP100-P-1818B *Lead-free		
Minimum Instruction Execution Time	Standard: 0.10 μs (at 4.5 V to 5.5 V, 20 MHz) 0.238 μs (at 2.7 V to 5.5 V, 8.39 MHz) 125 μs (at 2.0 V to 5.5 V, 32 kHz)* Double speed: 0.12 μs (at 4.5 V to 5.5 V, 8.39 MHz) 0.25 μs (at 3.0 V to 5.5 V, 4 MHz) 62.5 μs (at 2.0 V to 5.5 V, 32 kHz)* * The lower limit for operation guarantee for EPROM built-in type is 2.7 V. * The lower limit for operation guarantee for flash memory built-in type is 4.5 V.		
Interrupts	• RESET • Watchdog • External 0 • External 1 • External 2 • External 3 • External 4 • External 5 • Timer 0 • Timer 1 • Timer 2 • Timer 3 • Timer 4 • Timer 6 • Timer 7 (2 systems) • Time base • Serial 0 • Serial 1 • Serial 2 • Serial 3 • Automatic transfer finish • A/D conversion finish • Key interrupts (8 lines)		
Timer Counter	<p>Timer counter 0 : 8-bit × 1 (square-wave/8-bit PWM output, event count, generation of remote control carrier, pulse width measurement) Clock source 1/2, 1/4 of system clock frequency; 1/1, 1/4, 1/16, 1/32, 1/64 of OSC oscillation clock frequency; 1/1 of XI oscillation clock frequency; external clock input Interrupt source coincidence with compare register 0</p> <p>Timer counter 1 : 8-bit × 1 (square-wave output, event count, synchronous output event) Clock source 1/2, 1/8 of system clock frequency; 1/1, 1/4, 1/16, 1/64, 1/128 of OSC oscillation clock frequency; 1/1 of XI oscillation clock frequency; external clock input Interrupt source coincidence with compare register 1</p> <p>Timer counter 0, 1 can be cascade-connected.</p> <p>Timer counter 2 : 8-bit × 1 (square-wave/8-bit PWM output, event count, synchronous output event, pulse width measurement) Clock source 1/2, 1/4 of system clock frequency; 1/1, 1/4, 1/16, 1/32, 1/64 of OSC oscillation clock frequency; 1/1 of XI oscillation clock frequency; external clock input Interrupt source coincidence with compare register 2</p> <p>Timer counter 3 : 8-bit × 1 (square-wave output, event count, generation of remote control carrier) Clock source 1/2, 1/8 of system clock frequency; 1/1, 1/4, 1/16, 1/64, 1/128 of OSC oscillation clock frequency; 1/1 of XI oscillation clock frequency; external clock input Interrupt source coincidence with compare register 3</p> <p>Timer counter 2, 3 can be cascade-connected.</p> <p>Timer counter 4 : 8-bit × 1 (square-wave/8-bit PWM output, event count, pulse width measurement, serial 1 baud rate timer) Clock source 1/2, 1/4 of system clock frequency; 1/1, 1/4, 1/16, 1/32, 1/64 of OSC oscillation clock frequency; 1/1 of XI oscillation clock frequency; 1/1 of external clock input frequency Interrupt source coincidence with compare register 4</p> <p>Timer counter 6 : 8-bit freerun timer Clock source 1/1 of system clock frequency; 1/1, 1/4096, 1/8192 of OSC oscillation clock frequency; 1/1, 1/4096, 1/8192 of XI oscillation clock frequency Interrupt source coincidence with compare register 6</p>		

Timer Counter (Continue)		<p>Timer counter 7 : 16-bit × 1 (square-wave/16-bit PWM output, cycle / duty continuous variable, event count, synchronous output event, pulse width measurement, input capture) Clock source 1/1, 1/2, 1/4, 1/16 of system clock frequency; 1/1, 1/2, 1/4, 1/16 of OSC oscillation clock frequency; 1/1, 1/2, 1/4, 1/16 of external clock input frequency Interrupt source coincidence with compare register 7 (2 lines)</p> <p>Time base timer (one-minute count setting) Clock source 1/1 of OSC oscillation clock frequency; 1/1 of XI oscillation clock frequency Interrupt source 1/128, 1/256, 1/512, 1/1024, 1/8192, 1/32768 of clock source frequency</p> <p>Watchdog timer Interrupt source 1/65536, 1/262144, 1/1048576 of system clock frequency</p> <p>DMA controller (automatic data transfer) Max. Transfer cycles 255 Starting factor external request, various types of interrupt, software Transfer mode 1-byte transfer, word transfer, burst transfer</p>	
Serial Interface		<p>Serial 0 : synchronous type/UART (full-duplex) × 1 Clock source 1/2, 1/4 of system clock frequency; pulse output of timer counter 2, 4; 1/2, 1/4, 1/16, 1/64 of OSC oscillation clock frequency</p> <p>Serial 1 : synchronous type/simple UART (half-duplex) × 1 Clock source 1/2, 1/4 of system clock frequency; pulse output of timer counter 4; 1/2, 1/4, 1/16, 1/64 of OSC oscillation clock frequency</p> <p>Serial 2 : synchronous type × 1 Clock source 1/2, 1/4 of system clock frequency; pulse output of timer counter 3; 1/2, 1/4, 1/16, 1/32 of OSC oscillation clock frequency</p> <p>Serial 3 : synchronous type/single-master I²C × 1 Clock source 1/2, 1/4 of system clock frequency; pulse output of timer counter 3; 1/2, 1/4, 1/16, 1/32 of OSC oscillation clock frequency</p>	
I/O Pins	I/O	73 (72)	<ul style="list-style-type: none"> • Common use • Specified pull-up resistor available • Input/output selectable (bit unit) () : Flash memory built-in type.
	Input	15 (14)	<ul style="list-style-type: none"> • Common use • Specified pull-up resistor available () : Flash memory built-in type.
A/D Inputs		10-bit × 8-ch. (with S/H)	
D/A Outputs		8-bit × 4-ch.	
Special Ports		Buzzer output, remote control carrier signal output, high-current drive port	

See the next page for electrical characteristics, pin assignment and support tool.

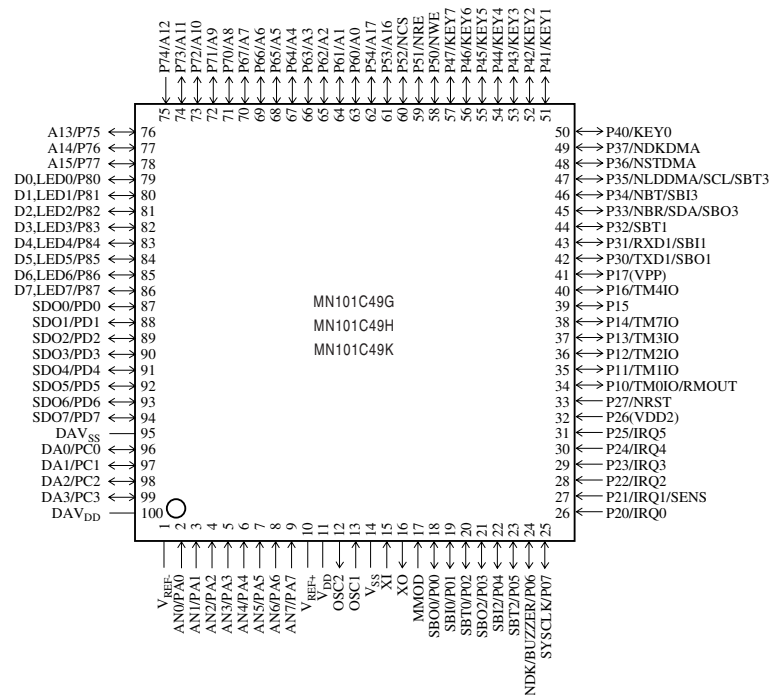
Electrical Characteristics

Supply current

Parameter	Symbol	Condition	Limit			Unit
			min	typ	max	
Operating supply current	IDD1	fosc = 20 MHz, VDD = 5 V		30	70	mA
	IDD2	fosc = 8.39 MHz, VDD = 5 V		15	30	mA
	IDD3	fx = 32.768 kHz, VDD = 3 V		40	120	μA
Supply current at HALT	IDD4	fx = 32 kHz, VDD = 3 V (5 V), Ta = 25°C		5 (13)	11 (30)	μA
	IDD5	fx = 32.768 kHz, VDD = 3 V (5 V), Ta = 85°C (70°C)			30 (90)	μA
Supply current at STOP	IDD6	VDD = 5 V, Ta = 25°C			3	μA
	IDD7	VDD = 5 V, Ta = 85°C (70°C)			60	μA

() : Flash memory built-in type.

Pin Assignment



QFP100-P-1818B *Lead-free

() : Flash memory built-in type.

Support Tool

■	In-circuit Emulator		PX-ICE101C / D + PX-PRB101C49-QFP100-P-1818B
	■ EPROM Built-in Type		
	Type	MN101CP49K	
	ROM (× 8-bit)	224 K	
	RAM (× 8-bit)	10 K	
	Minimum instruction execution time	Standard:	0.10 μs (at 4.5 V to 5.5 V, 20 MHz) 0.25 μs (at 2.7 V to 5.5 V, 8.39 MHz) Double speed: 0.12 μs (at 4.5 V to 5.5 V, 8.39 MHz) 0.25 μs (at 3.0 V to 5.5 V, 4 MHz)
	Package	QFP100-P-1818B *Lead-free	
■	Flash Memory Built-in Type		
	Type	MN101CF49K [ES (Engineering Sample) available]	
	ROM (× 8-bit)	224 K	
	RAM (× 8-bit)	10 K	
	Minimum instruction execution time	Standard:	0.10 μs (at 4.5 V to 5.5 V, 20 MHz) Double speed: 0.12 μs (at 4.5 V to 5.5 V, 8.39 MHz)
	Package	QFP100-P-1818B *Lead-free	

Request for your special attention and precautions in using the technical information and semiconductors described in this material

- (1) An export permit needs to be obtained from the competent authorities of the Japanese Government if any of the products or technical information described in this material and controlled under the "Foreign Exchange and Foreign Trade Law" is to be exported or taken out of Japan.
- (2) The technical information described in this material is limited to showing representative characteristics and applied circuits examples of the products. It neither warrants non-infringement of intellectual property right or any other rights owned by our company or a third party, nor grants any license.
- (3) We are not liable for the infringement of rights owned by a third party arising out of the use of the technical information as described in this material.
- (4) The products described in this material are intended to be used for standard applications or general electronic equipment (such as office equipment, communications equipment, measuring instruments and household appliances).
Consult our sales staff in advance for information on the following applications:
 - Special applications (such as for airplanes, aerospace, automobiles, traffic control equipment, combustion equipment, life support systems and safety devices) in which exceptional quality and reliability are required, or if the failure or malfunction of the products may directly jeopardize life or harm the human body.
 - Any applications other than the standard applications intended.
- (5) The products and product specifications described in this material are subject to change without notice for modification and/or improvement. At the final stage of your design, purchasing, or use of the products, therefore, ask for the most up-to-date Product Standards in advance to make sure that the latest specifications satisfy your requirements.
- (6) When designing your equipment, comply with the guaranteed values, in particular those of maximum rating, the range of operating power supply voltage, and heat radiation characteristics. Otherwise, we will not be liable for any defect which may arise later in your equipment.
Even when the products are used within the guaranteed values, take into the consideration of incidence of break down and failure mode, possible to occur to semiconductor products. Measures on the systems such as redundant design, arresting the spread of fire or preventing glitch are recommended in order to prevent physical injury, fire, social damages, for example, by using the products.
- (7) When using products for which damp-proof packing is required, observe the conditions (including shelf life and amount of time let standing of unsealed items) agreed upon when specification sheets are individually exchanged.
- (8) This material may be not reprinted or reproduced whether wholly or partially, without the prior written permission of Matsushita Electric Industrial Co., Ltd.